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AMENDMENTS TO THE CLAIMS

- 1. (Cancelled)
- 2. (Cancelled)
- 3. (Withdrawn and Currently Amended) An adhesive resin composition for titanium or a titanium alloy, comprising: a thermosetting resin and an imidazole <u>silane</u> compound.
- 4. (Withdrawn) The adhesive resin composition for titanium or a titanium alloy according to claim
- 3, further comprising a thermoplastic resin.
- 5. (Cancelled)
- 6. (Cancelled)
- 7. (Withdrawn) The adhesive resin composition for titanium or a titanium alloy according to claim 4, wherein the thermoplastic resin has a fracture energy release rate G_{IC} of 4500J/m^2 or more.
- 8. (Withdrawn) The adhesive resin composition for titanium or a titanium alloy according to claim 4, wherein the thermosetting resin in the adhesive resin composition that has been cured is in a discontinuous phase as well as in a cohesive phase.
- 9. (Withdrawn) The adhesive resin composition for titanium or a titanium alloy according to claim 4, wherein the thermoplastic resin in the adhesive resin composition is a crystalline thermoplastic resin.
- 10. (Withdrawn) The adhesive resin composition for titanium or a titanium alloy according to claim 3,

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wherein the thermoplastic resin is an epoxy resin.

11. (Withdrawn) An adhesive resin film for titanium or a titanium alloy comprising the adhesive resin composition according to claim 3.

12. (Currently Amended) A prepreg comprising the <u>an</u> adhesive resin composition according to elaim 3 and reinforcing fibers, wherein the adhesive resin composition comprises a thermosetting resin and an imidazole silane compound.

13. (Original) The prepreg according to claim 12, wherein the reinforcing fibers are impregnated with the adhesive resin composition.

14. (Currently Amended) The prepreg according to claim 12, wherein the adhesive resin composition is placed disposed on a surface layer of the prepreg base material.

15. (Currently Amended) A prepreg comprising the <u>an</u> adhesive resin film according to claim 11 placed <u>disposed</u> on the surface layer of the prepreg <u>base material</u>, wherein the adhesive resin <u>film comprises a thermosetting resin and an imidazole silane compound</u>.

16. (Previously Presented) The prepreg according to claim 12, wherein the reinforcing fibers are carbon fibers.

17. (Cancelled)

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18. (Cancelled)

19. (Cancelled)

20. (Cancelled)

21. (Withdrawn) A composite material wherein titanium or a titanium alloy and an adherend are adhered to each other through an adhesive resin layer formed by curing the adhesive resin composition according to claim 3.

22. (Withdrawn) A composite material wherein titanium or a titanium alloy and an adherend are adhered to each other through an adhesive resin layer formed by curing the adhesive resin film according to claim 11.

23. (Withdrawn) The composite material according to claim 21, wherein the adherend is a plastic material or a metal material.

24.(Withdrawn) The composite material according to claim 23, wherein the adherend is a fiber-reinforced plastic.

25. (Withdrawn) A composite material wherein titanium or a titanium alloy and the prepreg according to claim 12 are adhered to each other.

26. (Withdrawn) The composite material according to claim 17, wherein the peel torque of the titanium or titanium alloy from the adherend, measured in compliance with ASTM D 1781-98, is

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5N-mm/mm or more.

- 27. (Cancelled)
- 28 (Cancelled)
- 29. (Cancelled)
- 30. (Cancelled)
- 31. (Withdrawn) A manufacturing method of a composite material comprising the steps of: applying an adhesive resin composition containing a thermosetting resin and a thermoplastic resin to the surface of titanium or a titanium alloy; and conducting a heating process to a temperature of not less than the melting point of the thermoplastic resin.
- 32. (New) The prepreg according to claim 12, wherein the imidazole silane compound is indicated by one of the following formulas (II), (III) and (IV):

$$\begin{array}{c} R^6 \qquad R^7 \\ \searrow \qquad \qquad \\ N \qquad N - CH_2CHCH_2 - O - CH_2CH_2CH_2 - Si(OR^8)_n(R^9)_{3-n} \\ \downarrow \qquad \qquad OH \end{array} \tag{II}$$

$$\begin{array}{c} R^6 \\ \nearrow \\ N \\ \nearrow N - CH_2CHCH_2 - O - CH_2CH_2CH_2 \\ \downarrow \\ R^5 \\ O - Si(OR^8)_{n-1}(R^9)_{3-n} \end{array}$$

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wherein n is an integer of 1-3; R⁵ to R⁷ are substituents selected from the group consisting of a hydrogen atom, an alkyl group having 1-20 carbon atoms, an aminoalkyl group having 1-20 carbon atoms; a cyanoalkyl group having 2-20 carbon atoms, an aryl group having 6-20 carbon atoms and an aralkyl group having 7-20 carbon atoms; and R⁸ and R⁹ are an alkyl group having 1-4 carbon atoms.